BYT51.

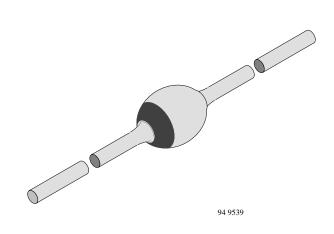
Silicon Mesa Rectifiers

Features

- Glass passivated junction
- Hermetically sealed package
- Low reverse current

Applications

Rectifiers



Absolute Maximum Ratings

 $T_j = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Value	Unit
Reverse voltage, peak reverse voltage		BYT51A	V _R , V _{RRM}	50	V
		BYT51B	V _R , V _{RRM}	100	V
		BYT51D	V _R , V _{RRM}	200	V
		BYT51G	V _R , V _{RRM}	400	V
		BYT51J	V _R , V _{RRM}	600	V
		BYT51K	V _R , V _{RRM}	800	V
		BYT51M	V _R , V _{RRM}	1000	V
Peak forward surge current	t _p =10ms		I _{FSM}	50	A
Repetitive peak forward current			I _{FRM}	9	А
Average forward current	Fig. 1		I _{FAV}	1	A
	$l=10$ mm, $T_L=30$ °C		I _{FAV}	1.5	A
Junction temperature			Tj	175	°C
Storage temperature range			T _{stg}	-65+175	°C

Maximum Thermal Resistance

 $T_j = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	l=10mm, T _L =constant	R _{thJA}	45	K/W
	on PC board with spacing 25mm	R _{thJA}	100	K/W

Characteristics

$T_i = 25^{\circ}C$

Parameter	Test Conditions	Туре	Symbol	Min	Тур	Max	Unit
Forward voltage	I _F =1A		V _F		0.95	1.1	V
	I _F =1A, T _j =175°C		V _F			1.0	V
Reverse current	V _R =V _{RRM}		I _R			1	μΑ
	V _R =V _{RRM} , T _j =150°C		I _R			100	μΑ
Reverse recovery time	$I_{F}=0.5A, I_{R}=1A, i_{R}=0.25A$		t _{rr}			4	μs

Typical Characteristics ($T_j = 25^{\circ}C$ unless otherwise specified)

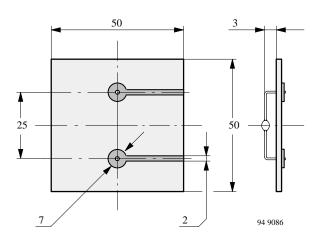


Figure 1 : Epoxy glass hard tissue, board thickness 1.5 mm, $$R_{thJA}\!\leq\!100~\text{K/W}$}$

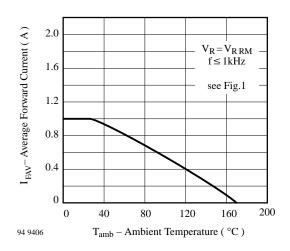


Figure 3 : Average Forward Current vs. Ambient Temperature

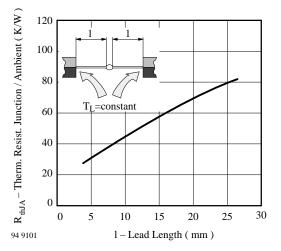


Figure 2 : Thermal Resistance vs. Lead Length

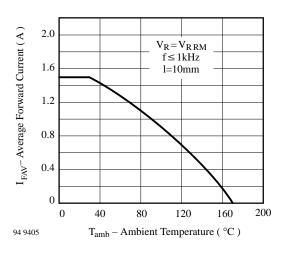


Figure 4 : Average Forward Current vs. Ambient Temperature

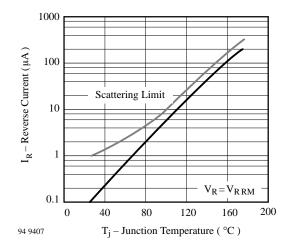


Figure 5 : Reverse Current vs. Junction Temperature

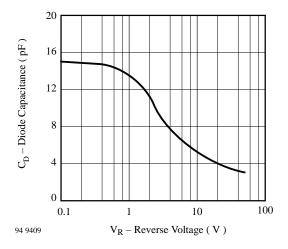
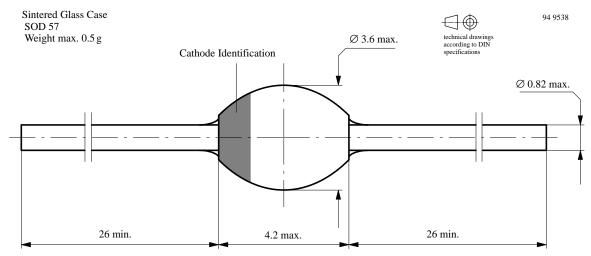


Figure 7 : Diode Capacitance vs. Reverse Voltage

Dimensions in mm



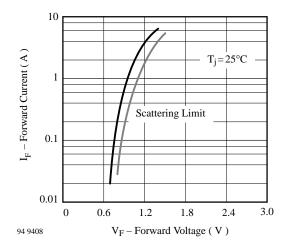


Figure 6 : Forward Current vs. Forward Voltage

Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes without further notice to improve technical design. Parameters can vary in different applications. All operating parameters must be validated for each customer application by customer. Should Buyer use TEMIC products for any unintended or unauthorized application, Buyer shall idemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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